

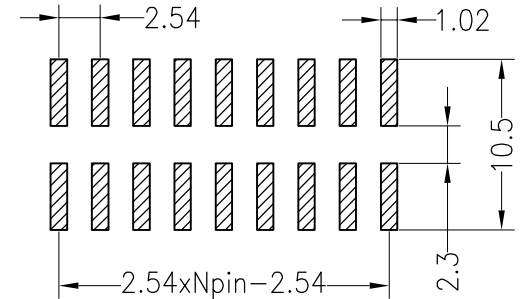
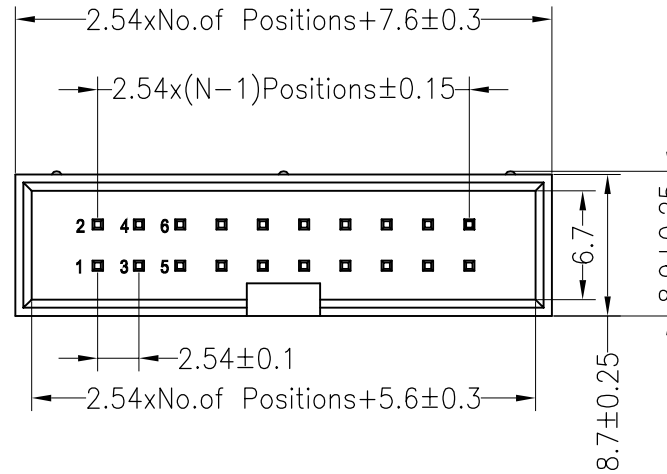


**SPECIFICATIONS**

Rated Current:3.0AMP  
 Contact Resistance:20mΩ Max  
 Withstand Voltage:1000V AC/DC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°C to +105°C

Contact Material:Brass  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:Polyester(UL94V-0)  
 Standard: PA6T  
 Max.Processing Temp: 230°C for 30-60 seconds  
 (260°C for 10 seconds)

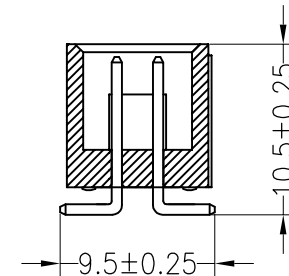
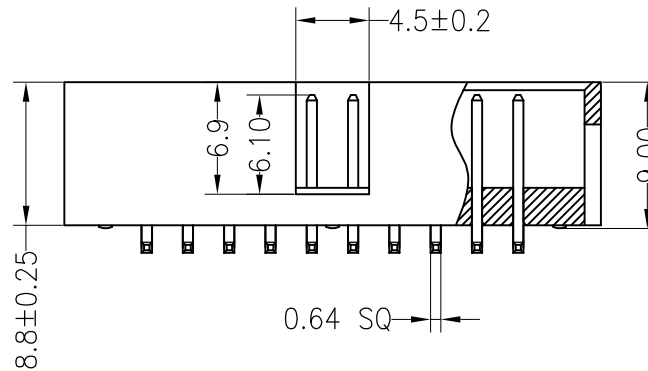
Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



**Ordering Information**

3210- XX M XX X B K00 X 01

- No.of Pins Per Row: 6--64
- Contact Plating: G0:Gold Flash, G1:3U" Gold, G2:5U" Gold, G3:10U" Gold, G4:15U" Gold, G5:30U" Gold, S0:Gold Flash/Tin, SN:Tin
- Insulator Material Option: A=BK-PBT, B=BK-PA66, C=BK-PA6T, D=BK-PA46, F=BK-LCP
- Packing: 0=PE Bag, A=Tray, T=Tube, P=Tube+Cap



				OPERATION		DRAW	卢能	2016.9.13	SCALE	FIT	深圳市连盛精密连接器有限公司		
				X.X	±0.30				UNIT	mm			
				X.XX	±0.20	CHECK		SIZE	A4	PART NO.			
				X.XXX	±0.10	APPROVE		SHEET	1/1	BH-00214			
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL				PROJ.	◆	TITLE:	2.54BOX H=8.8 SMT	
1	2	3	4	5	6	7	8	9					